MPL-AT2010-R68

Low-Profile Molded Inductor 0.68µH

APPLICATIONS

- Battery-powered devices
- High switching frequency SMPS
- IoT
- Wearable
- Portable devices
- Input filters

FEATURES

- Size 2.0mmx1.6mmx1.0mm
- Low Profile
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Low DCR
- Max Operating Temp +125°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

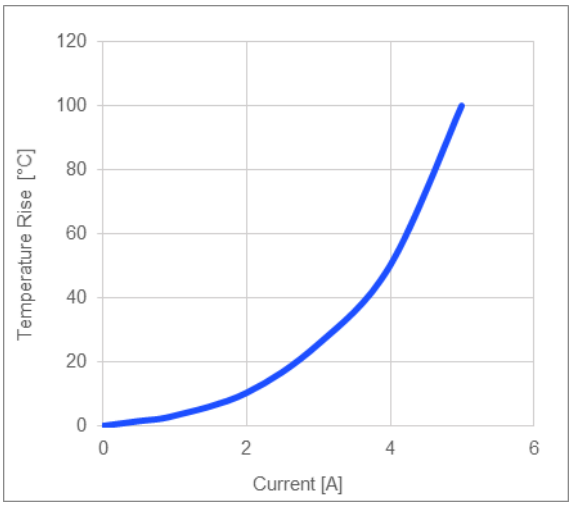
Parameter			Value	Unit
Inductance (1)	L	±20%	0.68	µH
Resistance	R_{DC}	typ	41	mΩ
Resistance MAX	$R_{DC\ MAX}$	max	50	mΩ
Rated Current (2)	I_R	typ	3.5	A
Saturation Current 25°C (3)	$I_{SAT\ 25°C}$	typ	4.9	A
Saturation Current 100°C (4)	$I_{SAT\ 100°C}$	typ	4.9	A
Resonance Frequency	f_r	typ	125	MHz

GENERAL SPECIFICATIONS

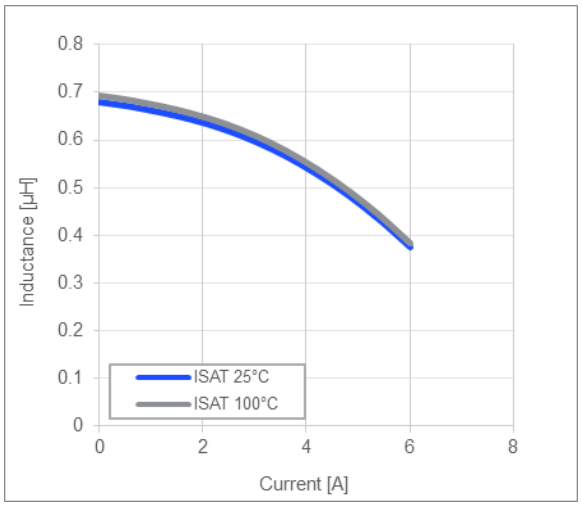
(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K *I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35µm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.*
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +125°C (including temp rise) Should not exceed +125°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

TYPICAL PERFORMANCE CURVES

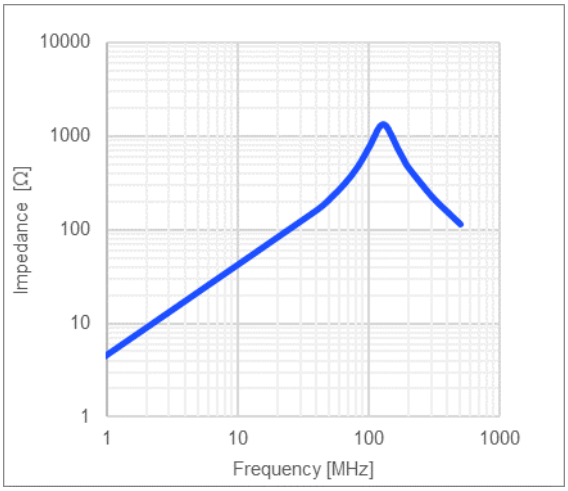
Temperature Rise vs. Current



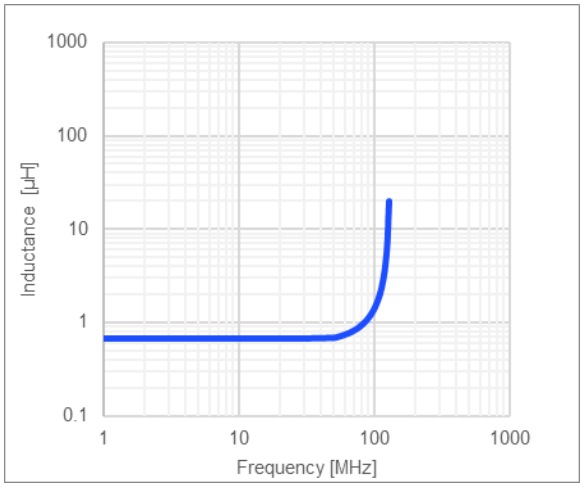
Inductance vs. Current



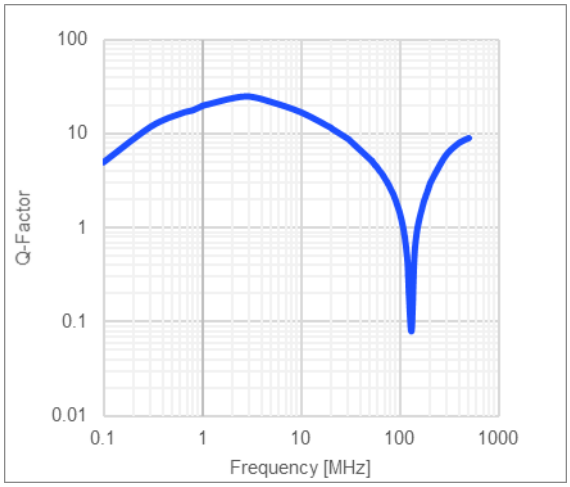
Impedance vs. Frequency



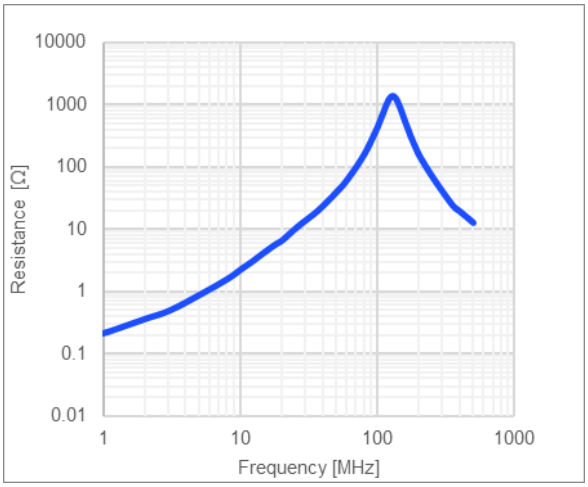
Inductance vs. Frequency



Quality Factor vs. Frequency

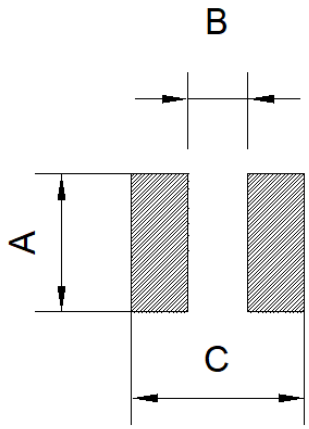


AC Resistance vs. Frequency



LAND PATTERN

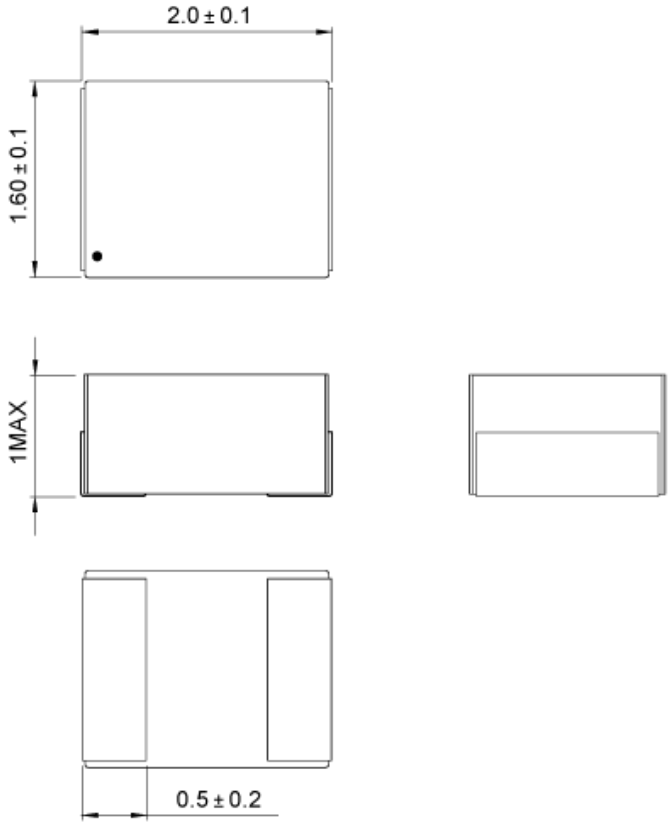
Dimensions	
A	1.60 ref.
B	0.70 ref.
C	2.0 ref.
	(unit in mm)



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING

Marking	
Start of Winding	· (dot)

ORDERING INFORMATION

Part Number	L (1) typ (µH)	R_{DC} typ (mΩ)	I_R (2) typ (A)	$I_{SAT\ 25°C}$ (3) typ (A)	$I_{SAT\ 100°C}$ (4) typ (A)
MPL-AT2010-R47	0.47	27	4.4	5.7	5.7
MPL-AT2010-R68	0.68	41	3.5	4.9	4.9
MPL-AT2010-1R0	1.0	50	3.2	4.2	4.2
MPL-AT2010-1R5	1.5	97	2.4	3.2	3.2
MPL-AT2010-2R2	2.2	137	2.2	2.7	2.7
MPL-AT2010-4R7	4.7	215	1.5	1.9	1.9

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(4) **Saturation Current** $_{100°C}$	Saturation current will cause L to drop from 30% at 100°C ambient temperature
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